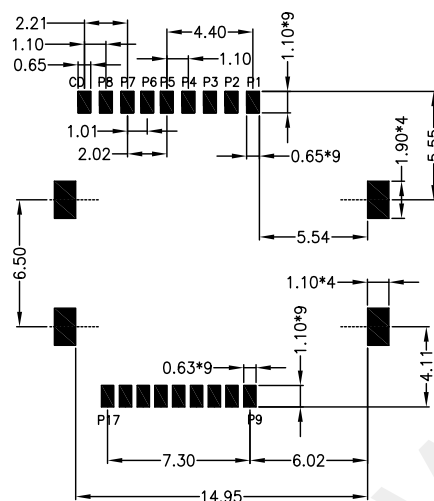
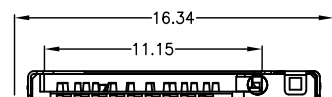
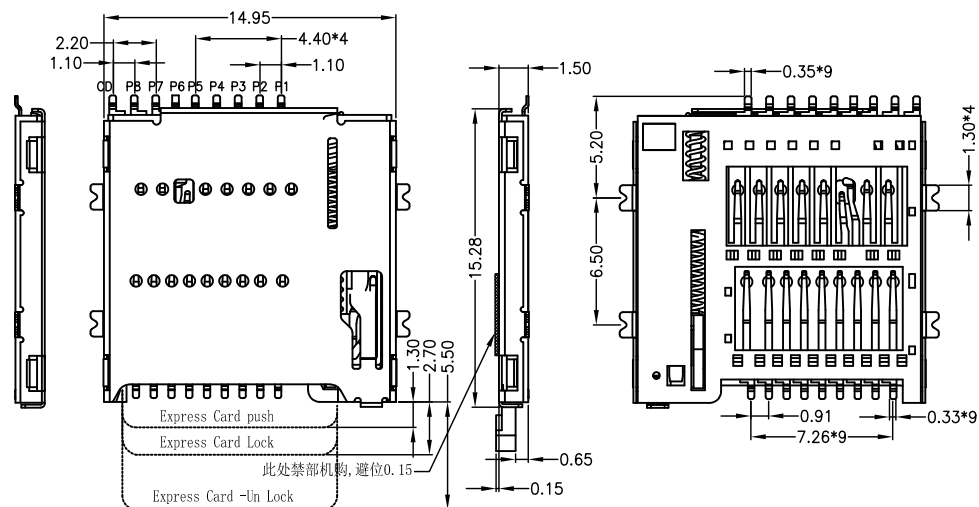
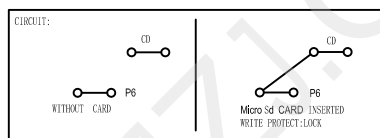
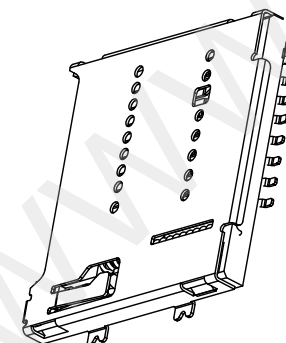
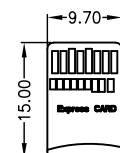




RECOMMEND PCB LAYOUT:  PCB AREA 焊接区
(Unit:mm .X ± 0.15 .XX ± 0.05 .XXX ± 0.02)



PIN NO.	PIN ASSIGNMENT	
1#	DAT2	信号
2#	CD/DAT3	信号
3#	CMD	数据输入
4#	VDD1	电压/电源
5#	CLK	时钟
6#	Vss	接地
7#	DAT0/RCLK+	
8#	DAT1/RCLK-	
CD	检测P	
P9	Vdd2	sample voltage(1.5V)
P10	Vss	sample voltage ground
P11	PCle TX +	PCle Transmit lane(Host to card)
P12	PCle TX -	PCle Transmit lane(Host to card)
P13	Vss	Supply voltage ground
P14	PCle Rx -	PCle Receive lane(Card to Host)
P15	PCle Rx +	PCle Receive lane(Card to Host)
P16	Vss	sample voltage ground
P17	VDD3	Supply voltage (1.2V)



MATERIAL: Specification
Insulator: High Temperature Thermoplastic,
UL 94V-0. COLOR:BLACK LCP
(塑胶: 黑色LCP, 防火等级UL 94V-0)
SHELL: SUS301
Contact: Copper Alloy (磷铜C5210)
弹簧: 琴钢丝
拉杆: SUS301

PLATING:
Contact:All Ni50u,contact area 1u Au,Pad 0.8u Au
(接触端子电镀: 全部镀底50u, 接触区域1u金, 焊脚处0.8u金最少)
Shell:All 50u Ni,Pad 0.8 u Au
(外壳电镀: 镀底50u, 焊接处0.8u金)

Electrical:
Current Rating :0.5Amps max(额定电流:0.5A最大)
Voltage Rating :5V AC/DC(额定电压:5V AC/DC)
Ambient Temperature Range :-20° C~+60° C(工作温度: -20度到+60度)
Storage Temperature Range :-40° C~+70° C(工作温度: -20度到+80度)
Ambient Humidity Range :95% R.H. Max. (上锡效果: 95%以上)
Contact Resistance:100mΩmax. (端子接触电阻: 100mΩ最大)
Insulation Resistance:1000MΩmin./500VDC(绝缘阻抗: 100兆欧最小)
Mating Cycles:3,000 Insertions (寿命: 3000次)
产品耐温温度: 260° C



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5"	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: TF PUSH 7.1 全贴卡座 1.5H
CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYC134-TF18-150	MOLD NO.
APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2112281903	SHEET NO. 1 OF 1